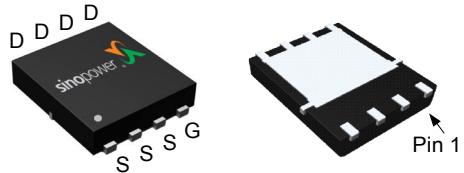


## N-Channel Enhancement Mode MOSFET

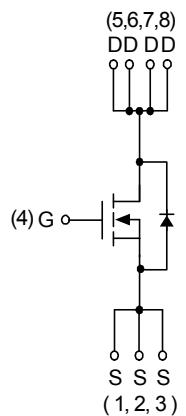
### Features

- 30V/49A,  
 $R_{DS(ON)} = 8.5\text{m}\Omega$  (max.) @  $V_{GS} = 10\text{V}$   
 $R_{DS(ON)} = 12\text{m}\Omega$  (max.) @  $V_{GS} = 4.5\text{V}$
- Provide Excellent Qgd x Rds-on
- 100% UIS +  $R_g$  Tested
- Reliable and Rugged
- Lead Free and Green Devices Available  
(RoHS Compliant)

### Pin Description



DFN5x6A-8\_EP

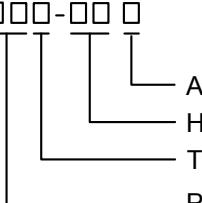


N-Channel MOSFET

### Applications

- Power Management in Desktop Computer or DC/DC Converters.

### Ordering and Marking Information

<p>SM4378NS □□□-□□ □</p> 	<p>Package Code KP : DFN5x6A-8_EP Operating Junction Temperature Range C : -55 to 150 °C Handling Code TR : Tape &amp; Reel Assembly Material G : Halogen and Lead Free Device</p>
<p>SM4378NS KP :</p> 	<p>XXXXX - Lot Code</p>

Note : SINOPOWER lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. SINOPOWER lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. SINOPOWER defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

SINOPOWER reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

## Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter		Rating	Unit
<b>Common Ratings</b>				
$V_{DSS}$	Drain-Source Voltage		30	V
$V_{GSS}$	Gate-Source Voltage		$\pm 20$	
$T_J$	Maximum Junction Temperature		150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range		-55 to 150	
$I_S$	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$	20	A
$I_D$	Continuous Drain Current	$T_C=25^\circ\text{C}$	49	
		$T_C=100^\circ\text{C}$	31	
$I_{DM}^a$	Pulsed Drain Current	$T_C=25^\circ\text{C}$	123	W
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	31	
		$T_C=100^\circ\text{C}$	12.5	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	3.9	$^\circ\text{C}/\text{W}$
$I_D$	Continuous Drain Current	$T_A=25^\circ\text{C}$	14.4	A
		$T_A=70^\circ\text{C}$	11.6	
$I_{DM}^a$	Pulsed Drain Current	$T_A=25^\circ\text{C}$	57.6	A
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	2.7	W
		$T_A=70^\circ\text{C}$	1.7	
$R_{\theta JA}^b$	Thermal Resistance-Junction to Ambient	$t \leq 10\text{s}$	20	$^\circ\text{C}/\text{W}$
		Steady State	47	
$I_{AS}^c$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	20	A
$E_{AS}^c$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	20	mJ

Note a : Pulse width is limited by maximum junction temperature.

Note b : Surface mounted on 1in<sup>2</sup> pad area, steady state t = 100s.

Note c : UIS tested and pulse width are limited by maximum junction temperature 150°C (initial temperature Tj=25°C).

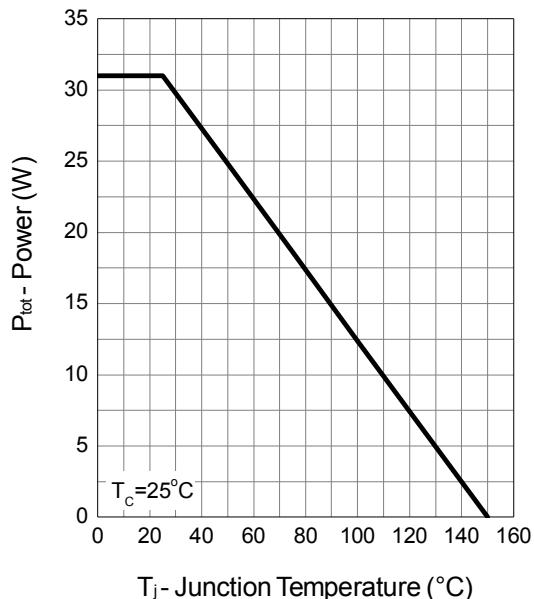
**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=250\mu\text{A}$	30	-	-	V
$\text{BV}_{\text{DSST}}$	Drain-Source Breakdown Voltage (transient)	$V_{\text{GS}}=0\text{V}, I_{\text{D}(\text{aval})}=15\text{A}$ $T_{\text{case}}=25^\circ\text{C}, t_{\text{transient}}=100\text{ns}$	34	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=24\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
		$T_J=85^\circ\text{C}$	-	-	30	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=250\mu\text{A}$	1.5	1.8	2.5	V
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
$R_{\text{DS(ON)}}^d$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{DS}}=20\text{A}$	-	7	8.5	$\text{m}\Omega$
		$T_J=125^\circ\text{C}$	-	10.5	-	
		$V_{\text{GS}}=4.5\text{V}, I_{\text{DS}}=10\text{A}$	-	9.2	12	
$G_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=5\text{V}, I_{\text{DS}}=10\text{A}$	-	40	-	S
<b>Diode Characteristics</b>						
$V_{\text{SD}}^d$	Diode Forward Voltage	$I_{\text{SD}}=15\text{A}, V_{\text{GS}}=0\text{V}$	-	0.84	1.1	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_{\text{SD}}=20\text{A}, dI_{\text{SD}}/dt=100\text{A}/\mu\text{s}$	-	12.1	-	ns
$t_a$	Charge Time		-	6.9	-	
$t_b$	Discharge Time		-	5.3	-	
$Q_{\text{rr}}$	Reverse Recovery Charge		-	4.9	-	nC
<b>Dynamic Characteristics</b>						
$R_G$	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$	0.3	0.9	2	$\Omega$
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=15\text{V},$ Frequency=1.0MHz	760	930	1100	pF
$C_{\text{oss}}$	Output Capacitance		100	147	200	
$C_{\text{rss}}$	Reverse Transfer Capacitance		65	94	120	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{DD}}=15\text{V}, R_L=15\Omega,$ $I_{\text{DS}}=1\text{A}, V_{\text{GEN}}=10\text{V},$ $R_G=6\Omega$	-	12	18	ns
$t_r$	Turn-on Rise Time		-	10	15	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	24	40	
$t_f$	Turn-off Fall Time		-	5.5	8	
<b>Gate Charge Characteristics</b>						
$Q_g$	Total Gate Charge	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=4.5\text{V},$ $I_{\text{DS}}=20\text{A}$	-	8	12	nC
$Q_g$	Total Gate Charge	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=10\text{V},$ $I_{\text{DS}}=20\text{A}$	-	16	21	
$Q_{\text{gth}}$	Threshold Gate Charge		-	1.3	1.8	
$Q_{\text{gs}}$	Gate-Source Charge		-	2.8	3.5	
$Q_{\text{gd}}$	Gate-Drain Charge		-	3.7	4.4	

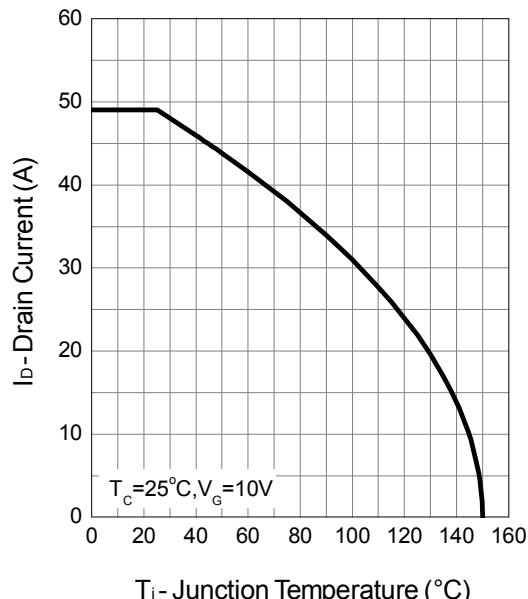
Note d : Pulse test; pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ .

## Typical Operating Characteristics

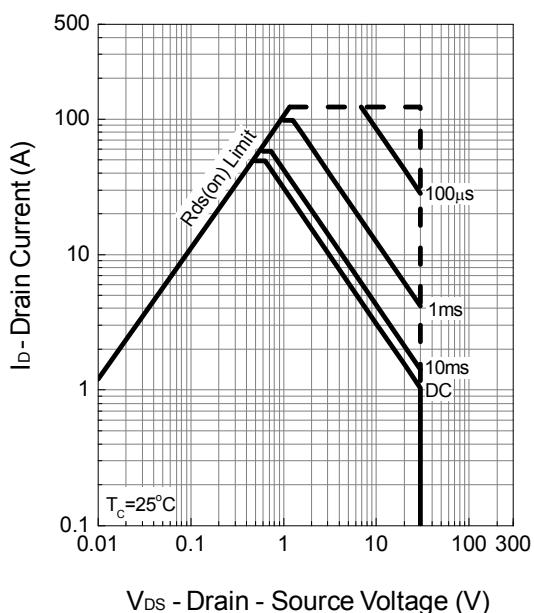
**Power Dissipation**



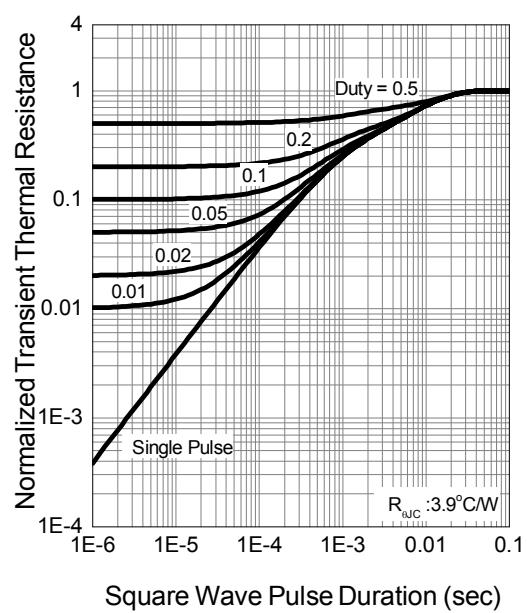
**Drain Current**



**Safe Operation Area**

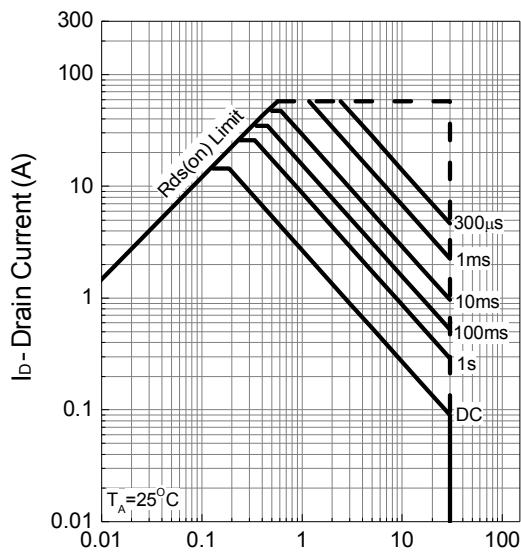


**Thermal Transient Impedance**



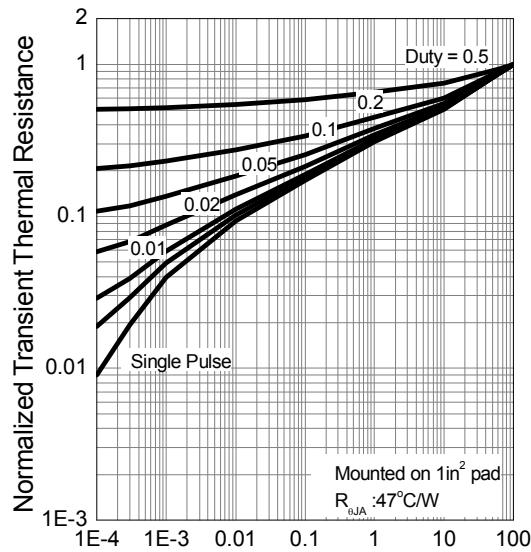
## Typical Operating Characteristics (Cont.)

**Safe Operation Area**



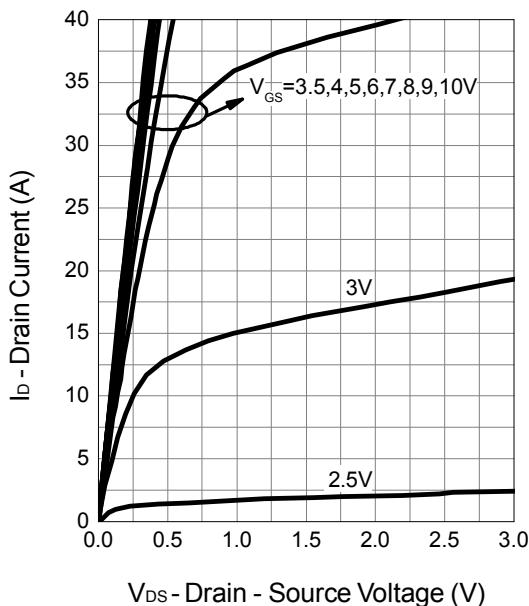
$V_{DS}$  - Drain - Source Voltage (V)

**Thermal Transient Impedance**



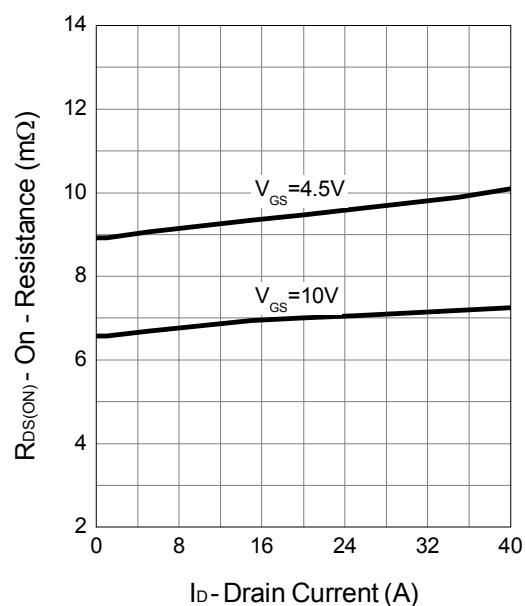
Square Wave Pulse Duration (sec)

**Output Characteristics**



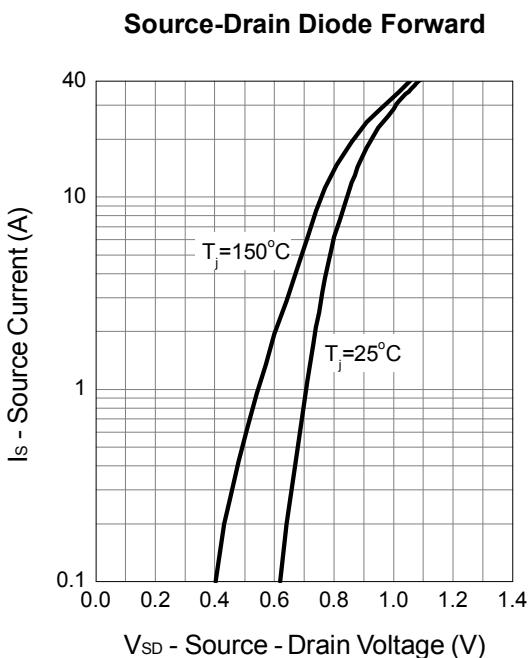
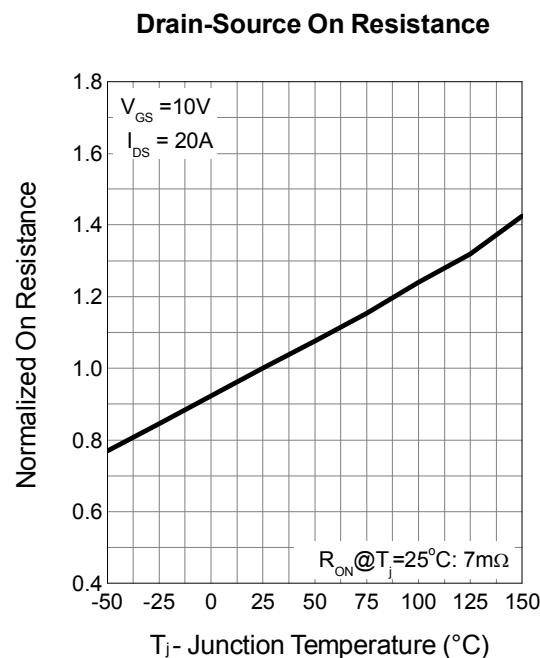
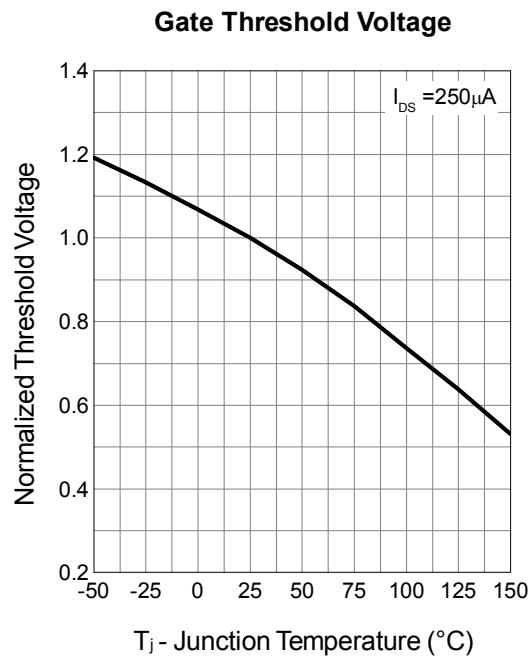
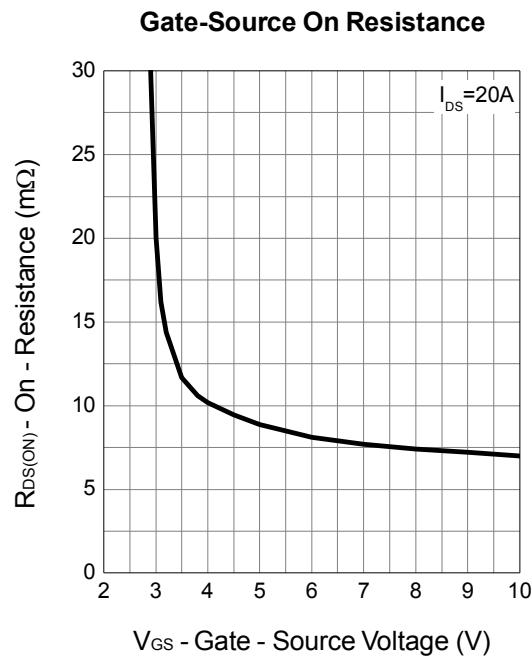
$V_{DS}$  - Drain - Source Voltage (V)

**Drain-Source On Resistance**

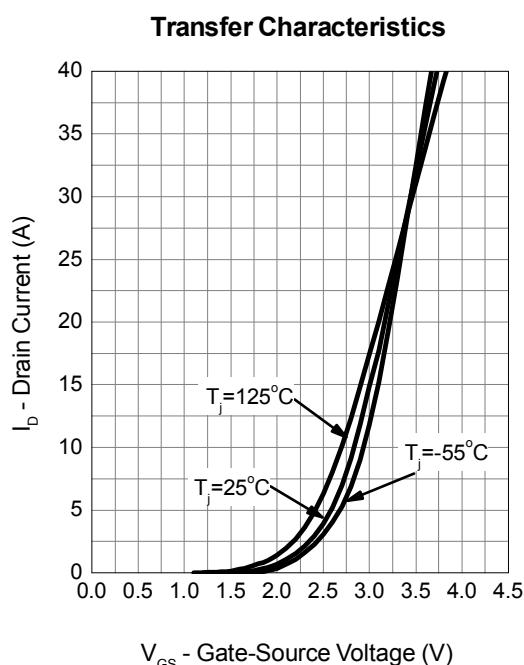
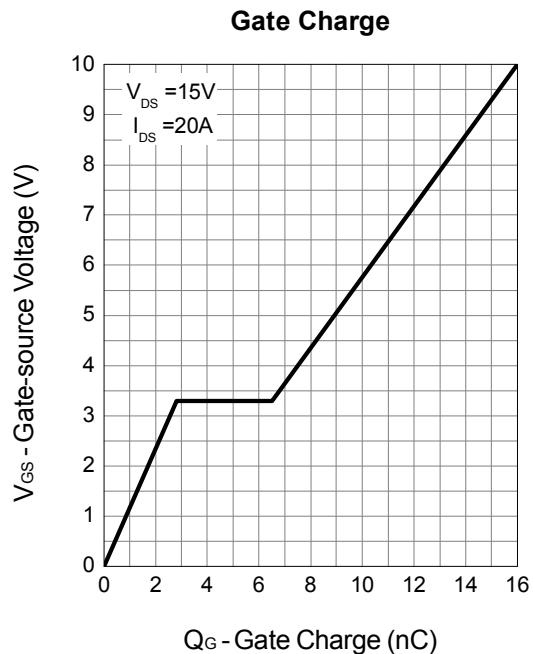
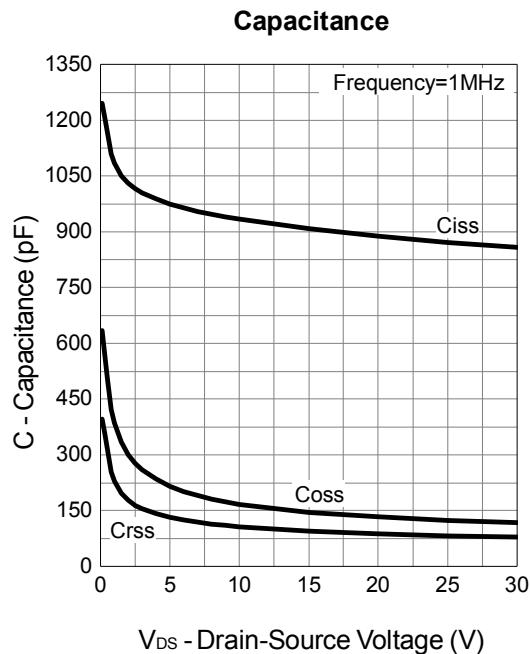


$I_D$  - Drain Current (A)

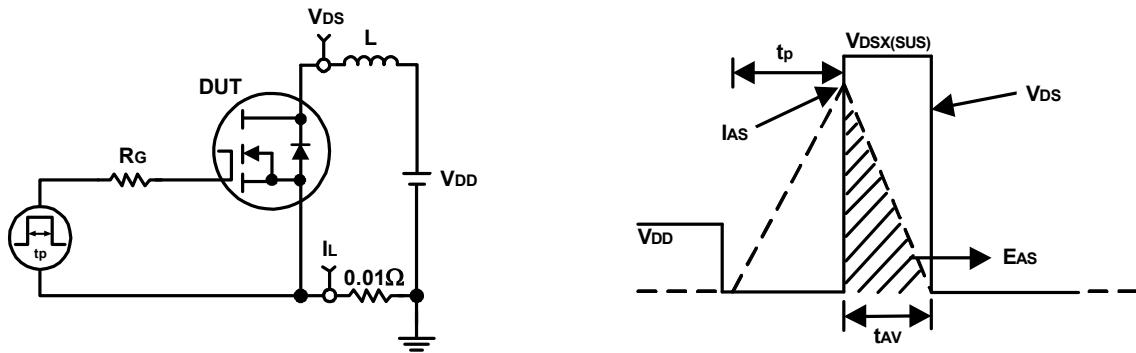
## Typical Operating Characteristics (Cont.)



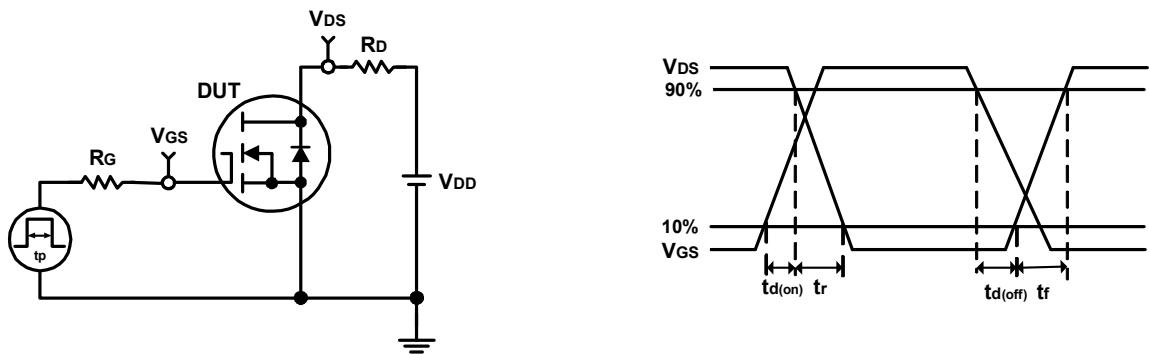
## Typical Operating Characteristics (Cont.)



## Avalanche Test Circuit and Waveforms



## Switching Time Test Circuit and Waveforms



## Disclaimer

Sinopower Semiconductor Inc. (hereinafter “Sinopower”) has been making great efforts to development high quality and better performance products to satisfy all customers’ needs. However, a product may fail to meet customer’s expectation or malfunction for various situations.

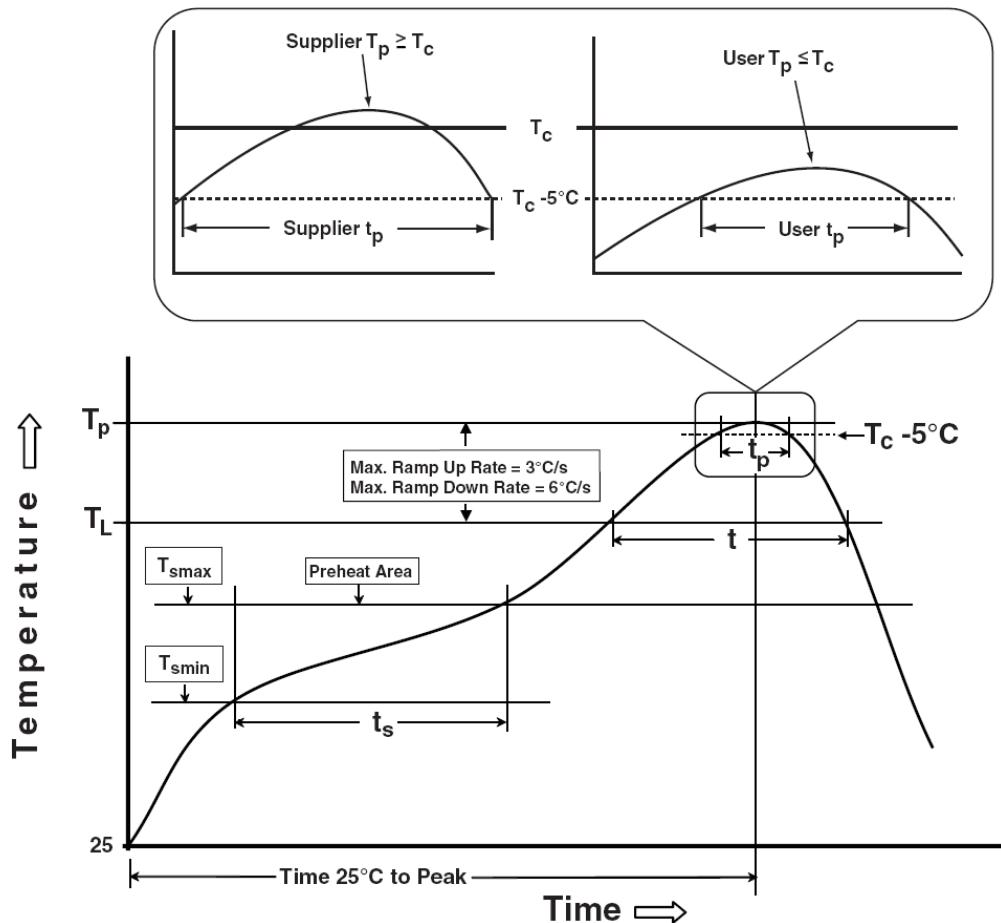
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## Classification Profile



## Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
<b>Preheat &amp; Soak</b>		
Temperature min ( $T_{smin}$ )	100 °C	150 °C
Temperature max ( $T_{smax}$ )	150 °C	200 °C
Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	60-120 seconds	60-120 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )	3 °C/second max.	3°C/second max.
Liquidous temperature ( $T_L$ )	183 °C	217 °C
Time at liquidous ( $t_L$ )	60-150 seconds	60-150 seconds
Peak package body Temperature ( $T_p$ )*	See Classification Temp in table 1	See Classification Temp in table 2
Time ( $t_p$ )** within 5°C of the specified classification temperature ( $T_c$ )	20** seconds	30** seconds
Average ramp-down rate ( $T_p$ to $T_{smax}$ )	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.

\* Tolerance for peak profile Temperature ( $T_p$ ) is defined as a supplier minimum and a user maximum.  
 \*\* Tolerance for time at peak profile temperature ( $t_p$ ) is defined as a supplier minimum and a user maximum.

Table 1. SnPb Eutectic Process – Classification Temperatures ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

## Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	1000 Hrs, 80% of VDS max @ Tjmax
HTGB	JESD-22, A108	1000 Hrs, 100% of VGS max @ Tjmax
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C

## Customer Service

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